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EPOXIDE ADVANCEMENT

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(71) Applicant(s)
IMPERIAL CHEMICAL INDUSTRIES PLC; HOLDEN EUROPE S.A.

(72) Inventor(s)
FREDERICK ANDREW WAITE; RONALD METCALFE

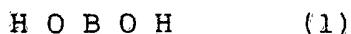
(74) Attorney or Agent
PHILLIPS ORMONDE & FITZPATRICK, 367 Collins Street, MELBOURNE VIC 3000

(56) Prior Art Documents
AU 68771/87 C08G
AU 567631 55143/86 C08F
AU 566379 47269/85 C08F

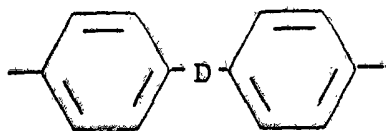
(57) This invention relates to a process for preparing sterically stabilised dispersions of epoxy resin particles in a non-polar organic liquid carrier.

CLAIM

1. A process for preparing a sterically stabilised non aqueous dispersion of a polyepoxide of epoxy equivalent weight in the range 350 to infinity, which comprises reacting a sterically stabilised non-aqueous dispersion of a compound with at least two epoxy groups with a diol of formula (1)



in which B is a group of formula (2)



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(2)

where B is a methylene group or propane -2, 2-diyl.

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Name(s) of Applicant(s):

Imperial Chemical Industries PLC and Holden Europe S.A

Address(es) of Applicant(s):

Imperial Chemical House,
Millbank,
London SW1P 3JF,
UNITED KINGDOM.

182, Rue Ludovic Becquet,
Saint Pierre les Elbeuf B.P.27,
76320 Caudebec Les Elbeuf,
FRANCE

Address for Service is:

PHILLIPS ORMONDE & FITZPATRICK
Patent and Trade Mark Attorneys
367 Collins Street
Melbourne 3000 AUSTRALIA

Complete Specification for the invention entitled:

EPOXIDE ADVANCEMENT

Our Ref : 114376
POF Code: 1453/1453

The following statement is a full description of this invention, including
the best method of performing it known to applicant(s):

Epoxide Advancement

This invention relates to a process for preparing sterically stabilised dispersions of epoxy resin particles in a non-polar organic liquid carrier.

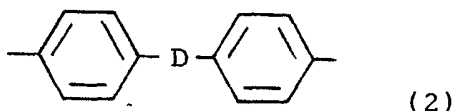
5 Known processes for producing non-aqueous dispersions of epoxy resins involve simple dispersion of the epoxy resin in a non-aqueous medium in the presence of a suitable stabiliser. An example of such a process is described in British Patent number
10 1 458 607. Commonly the epoxy resins are prepared by a process of epoxide advancement. In epoxide advancement suitable epoxides of low epoxy equivalent weight are reacted with difunctional materials such as
15 diols and this reaction results in epoxy resins of higher epoxy equivalent weight. Such a two stage process of an advancement step followed by a dispersion step is described in US patent number 4,579,887. In practice, it is found that such a two
20 stage process is very cumbersome. This is particularly so as the higher epoxy equivalent weight

epoxides are commonly highly viscous or solid at ambient temperatures and must be heated to high temperatures to allow the dispersion to be made. The dispersion step then usually either comprises feeding the continuous phase into the hot viscous epoxide melt or more commonly pumping the hot epoxide into the continuous phase. We have now found that it is possible to greatly simplify this former two stage process.

According to the present invention, there is provided a process for preparing a sterically stabilised non-aqueous dispersion of a polyepoxide of epoxy equivalent weight in the range 350 to infinity, which comprises reacting a sterically stabilised non aqueous dispersion of a compound with at least two epoxy groups with a diol of formula 1:



in which B is a group of formula (2)



where D is a methylene group or propane -2,2-diyl.

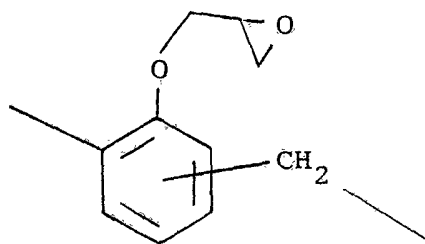
By 'polyepoxide' is meant a polymeric material which is derived in part from an epoxy functional starting material. It will be readily appreciated that the polyepoxide may be either epoxy terminated or aromatic hydroxyl terminated depending on the relative proportions of the diol of formula (1) and the compound with at least two epoxy groups used in the process. An excess of epoxide will result in a predominantly epoxy functional polyepoxide and an excess of diol will result in a predominantly hydroxy functional polyepoxide.

Referring to the diol of formula (1), B is preferably a group of formula (2) where D is propane-2,2-diyl. Diols of formula (1) are available commercially. Those where D is propane-2,2-diyl are known as bisphenol A or diphenylol propane (DPP). Those where D is methylene are known as bisphenol F, or diphenylol methane (DPM).

Minor proportions of the diol of formula (1) may be replaced by other difunctional compounds which will react with epoxy groups. Such difunctional compounds may for example, be added to improve the physical properties such as flexibility of films or blocks formed from the compositions by later removal of the continuous phase.

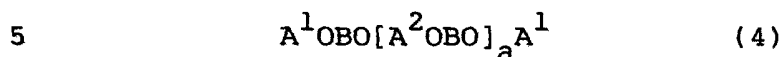
Examples of this are the improvements in flexibility obtained by the replacement of some of the diol with flexibilisers such as adipic acid or dimerised fatty acid.

An example of one class of polyepoxide which may be prepared by the process of the invention are those which are prepared by reacting an epoxy novolac compound with a diol of formula (1). Epoxy novolacs may be approximated as a phenol novolac resin containing groups such as those given in formula (3).



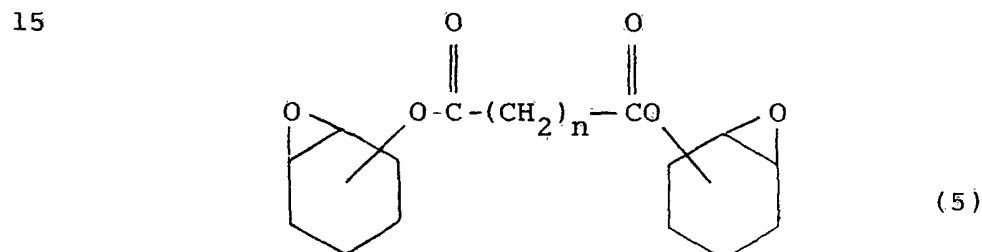
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An example of a preferred class of polyepoxide which may be prepared by the process of the invention are those of formula (4);

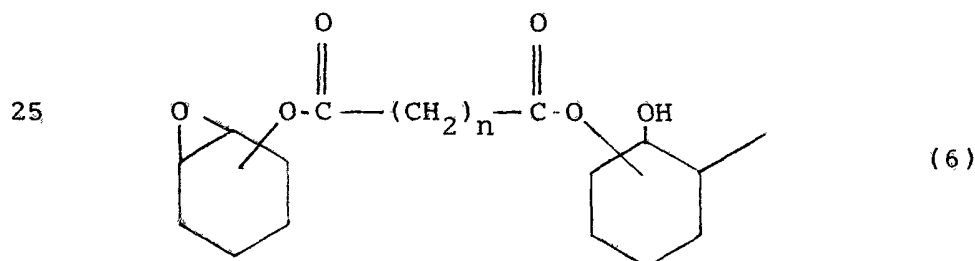


where a is a number such that the epoxy equivalent weight is in the range 350 to infinity, and B is a group of formula (2). Polyepoxides of formula (4) are prepared by reacting a diol of formula (1) with a
10 compound with two epoxy groups.

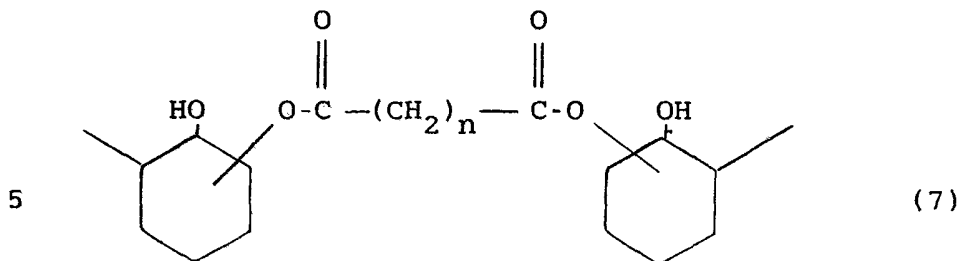
One example of a class of compounds with two epoxy groups useful in the process of the invention to give dispersions of polyepoxide of formula (4) are those of formula (5).



in which n is from 1 to 4. Use of a compound of formula (5) in the process of the invention gives rise to dispersions of formula (4) in which A^1 is hydrogen or a group of formula (6).
20

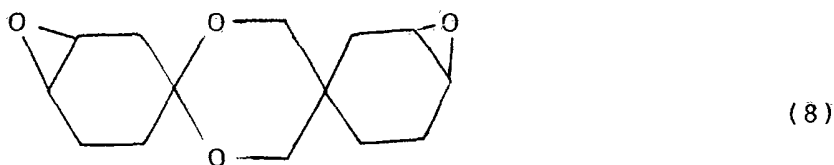


in which $\underline{n}$ is as defined in formula (5), and A^2 is a group of formula (7).

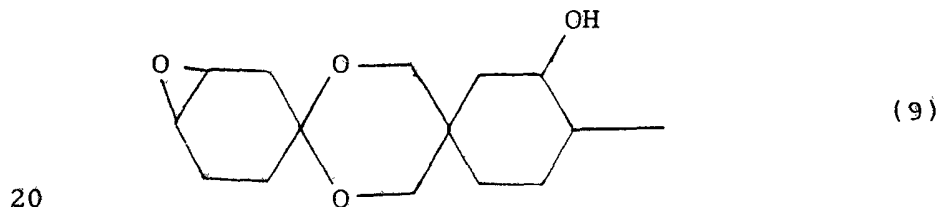


in which $\underline{n}$ is as defined in formula (5).

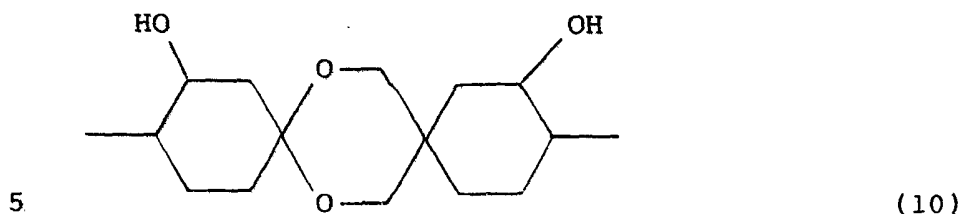
10 A further example of a compound with two epoxy groups useful in the process of the invention to give dispersions of polyepoxide of formula (4) is a compound of formula (8).



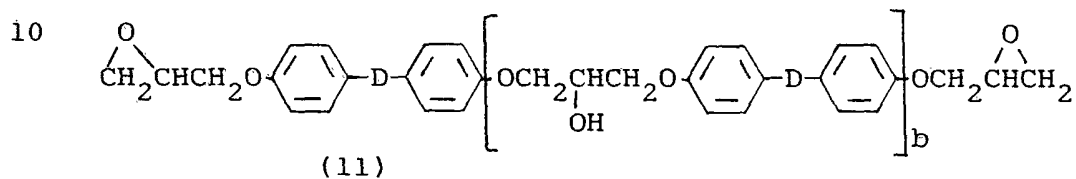
15 Use of a compound of formula (8) is the process of the invention gives rise to dispersions of formula (4) in which A^1 is hydrogen or a group of formula (9).



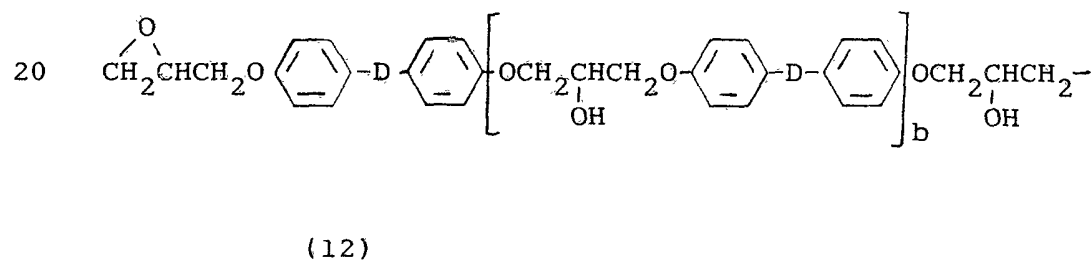
and A^2 is a group of formula (10)



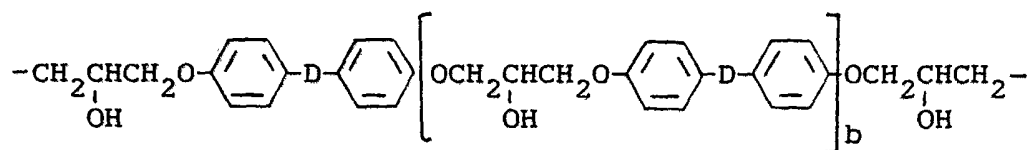
An example of a preferred class of compounds with two epoxy groups useful in the process of the invention to give dispersions of polyepoxide of formula (4) are those of formula (11).



15 where D is as defined with reference to formula (2) and b is from 0 to 2. Using compounds of formula (11) gives rise to dispersions of formula (4) in which A¹ is hydrogen or a group of formula (12);



25 where D and b are as defined with reference to formula (11), and in which A² is a group of formula (13).



(13)

5 where D and b are as defined with reference to formula (11). It will of course be appreciated that formulas (11), (12) and (13) are idealised structural formulae.

10 In practice the epoxy equivalent weight is 350 to 500,000, more particularly 350 to 250,000 or 350 to 25,000 or 350 to 15,000.

15 It will be understood by those skilled in the Art that where the polyepoxide product is predominantly aromatic hydroxy terminated it will have a very large epoxy equivalent weight.

20 Epoxy novolacs containing groups of approximate formula (3) may be made by the reaction of a novolac resin with epichlorohydrin. Epoxy novolacs of this type are commercially available from Ciba Giegy Chemicals as XPY 307 or EPN 1139 or from Dow Chemicals as DEN 438.

25 Referring to the diepoxides of formula (5) n is preferably 4. A diepoxide of formula (5) in which n is 4 is available as ERL 4299 from Ciba Giegy Chemicals.

A diepoxide of formula (8) is available as Diepoxide 133 from Degussa Chemicals.

30 Referring to the epoxide (11), D is preferably propane-2,2-diyl. Values for b can be 0, 1 or 2 or a fractional value.

The epoxides of formula (11) are commercially available and are supplied as mixtures with slight impurities so the value for $\underline{b}$ can be a fraction.

In particular, $\underline{b}$ is 0.1.

- 5 Examples of epoxides of Formula (11) which can be used in the process of this invention are:

Epikote 828 where D is propane-2,2-diyl and $\underline{b}$ is 0.1
GY 250 or DER 330 or DER 333 where D is propane-2,2-diyl and $\underline{b}$ is 0.1.

- 10 Epikote is a Registered Trade Mark and Epikote resins are available from Shell Chemicals. GY250 is available from Ciba-Giegy. DER 330 or DER 333 are from Dow Chemicals.

- 15 It will be understood that all of these epoxide functional compounds are technical grade materials subject to minor variations in structure and in the level of impurities.

- 20 The epoxides reacts with the diol in a sterically stabilised dispersion. The dispersion is maintained by a steric stabilising agent. A steric stabilising agent is a compound in which the molecule is essentially amphipathic. That is, it has chain-like part which associates with the epoxide to be dispersed (this is referred to as an anchor component) and
25 another chain-like part which associates with the liquid (this is referred to as a solvated component).

For example, the stabiliser can have an anchor component based on an acrylate polymer. Suitable acrylate polymers are homopolymers and co-polymers of

acrylic acid esters (for example polymethyl methacrylate, polyethyl methacrylate, polymethyl acrylate, polymethyl methacrylate, co-ethyl methacrylate polyethyl acrylate) and co-polymers of
 5 acrylate esters and acrylic and methacrylic acid. In such co-polymers, acrylic acid or methacrylic acid derived units make up no more than 10% by weight of the co-polymer. There may also be present minor proportions of itaconic acid, crotonic acid maleic
 10 acid or alkyl esters of those acids.

The solvated component can be a poly C₆₋₁₈ alkyl acrylic ester for example poly-2-ethyl hexyl acrylate, a polyester, for example poly-12-hydroxy stearic acid or a hydrocarbon, for example polybutadiene or
 15 degraded natural rubber.

Preferably the stabiliser is one where the anchor component is a co-polymer of methyl methacrylate and acrylic acid or methacrylic acid. Preferably the stabiliser is one where the solvated component is
 20 derived from polybutadiene.

The stabilisers can be made by standard methods. For example, where the anchor component is an acrylate polymer and the solvated component is poly-12-hydroxy stearic acid, the stabiliser can be prepared by
 25 co-polymerising the reaction product of glycidyl-(meth)acrylate and poly-12-hydroxystearic acid and the acrylate monomers. Where the anchor component is an acrylate polymer and the solvated component is a hydrocarbon or a poly C₆₋₁₈ alkyl acrylic ester the
 30 stabiliser can be made by a hydrogen abstraction reaction.

The liquid carrier for the dispersion is a non-polar organic liquid. It can be in particular an aliphatic hydrocarbon. The hydrocarbon can contain up to 30% by weight of other solvents for example, aromatic hydrocarbons and esters.

Preferably, the liquid carrier is a medium to high boiling aliphatic hydrocarbon particularly a hydrocarbon having a boiling point in the range 130-350°C.

The process is preferably carried out in the presence of a base catalyst. Examples of suitable catalysts are alkali metal carbonates for example sodium carbonate and potassium carbonate, alkali metal hydroxides, for example, sodium hydroxide and potassium hydroxide, quaternary ammonium salts and triaryl alkyl phosphonium salts for example, triphenyl ethyl phosphonium iodide and triphenyl ethyl phosphonium acetate.

Preferably the catalyst is triphenyl ethyl phosphonium iodide.

The sterically stabilised non aqueous dispersion of the compound with at least two epoxy groups may be produced by stirring the compound in the non-aqueous medium in the presence of the stabiliser.

The process may be carried out by slowly adding the diol of formula (1) to a preformed sterically stabilised dispersion of the compound with at least two epoxy groups at a suitable temperature so as to cause the components to react.

5 Preferably the process may be carried out by firstly mixing the diol of formula (1) with the compound with two epoxy groups and any catalyst for the reaction, subsequently forming a non aqueous dispersion of the mixture in the presence of a steric stabiliser and finally heating the dispersion to cause the components to react.

The reaction may be conveniently carried out at temperatures between 120 and 250°C.

10 Generally the components are heated for between one and four hours.

15 Certain dispersions of polyepoxides produced according to the process are novel. Accordingly, the invention also provides a sterically stabilised non-aqueous dispersion of a polyepoxide as previously defined where the dispersion is maintained by a steric stabiliser in which the solvated component is derived from polybutadiene.

20 It has been found that films cast upon metal substrates from dispersions in which such a preferred stabiliser is used and which are subsequently dried by heating exhibit improved adhesion to the substrate.

Preferably these dispersions have a solids content of at least 60%.

25 The dispersion produced by the process may be applied by standard methods to suitable substrates.

The present invention also provides a coating process which comprises applying a film of a dispersion as described above and removing the continuous phase by evaporation.

- 5 Examples of suitable application methods include spraying, brushing dipping or rollercoating.

After application the continuous phase is conveniently removed by heating to between 100 and 200°C for between 1 and 10 minutes.

- 10 The present invention also provides a coated article which has been coated according to the above coating process.

- 15 The dispersions produced by the process of this invention can be formulated by standard methods so as to produce coating compositions. They are particularly suitable for can coatings.

The following Examples illustrate the invention.

EXAMPLESExample 11.1 Poly-12-hydroxystearic acid

5 A mixture of 12-hydroxystearic acid (847.61 g),
 toluene (150.69 g), and methane sulphonic acid (1.70g)
 was heated to between 140-150°C. Water was removed
 azeotropically and was replaced during its removal by
 an equal volume of toluene. Water removal was con-
 10 tinued from 6 to 7 hours until the acid value was
 between 32 and 34 mg g⁻¹.

The product obtained was a solution of poly-12-
 hydroxystearic acid in toluene of solids content 81%.

1.2 Poly-12-hydroxystearic Acid: Glycidyl
Methacrylate Adduct

15 A mixture was made up of the following reagents:-

poly-12-hydroxystearic acid solution

(81% in toluene)

565.19g

Hydrosol 130-160°C; <5%

21.29g

glycidylmethacrylate

51.63g

20 Armeen DMCD

1.92g

hydroquinone

0.67g

Hydrosol 130-160°C; <5%

359.30g

(Armeen DMCD is dimethyl "coconut fatty amine")

(Hydrosol 130-160°C <5% is an aliphatic hydrocarbon

25 mixture containing less than 5% of aromatic

hydrocarbon available from Hydrocarbures St Denis, France).

5. The mixture as described above was heated to reflux (140-150°C) for 6 hours until an acid value of 1mg g^{-1} was obtained. Further amounts (0.67 g each) of Armeen DMCD were added to the refluxing mixture after 3 and 4 hours of reflux. The product was a solution of adduct of 50% solids content.

1.3 Poly-12-hydroxystearic Acid Based Dispersant

- 10 The following mixture of reagents was made up:-

	methyl methacrylate	190.05 g
	acrylic acid	10.00 g
	azodiisobutyronitrile	3.96 g
	poly-12-hydroxystearic acid-	
15	glycidyl methacrylate adduct	395.90 g

- 20 The reaction mixture as described above was added over 3 hours to a mixture of butyl acetate (133.37 g) and ethyl acetate (266.72 g) at reflux temperature. When the addition had been completed, heating was continued. After 30 minutes a portion of azodiisobutyronitrile slurry in ethyl acetate (1g in 1.5 g) was added to the reaction mixture. After a further 30 minutes another portion of azodiisobutyronitrile slurry in ethyl acetate (1g in 1.5g) was added.

- 25 Following the addition of the second portion of azodiisobutyronitrile, part of the solvent (140g) was removed by distillation and replaced by Hydrosol 130-160°C <5% (140 g). A further portion (140g) of

solvent was removed by distillation and replaced by a further portion (140g) of Hydrosol 130-160°C <5%.

1.4 Epoxide Diol Reaction

5 A mixture of epoxide GY250 (343.35 g), diphenylol propane (201.23 g), triphenyl ethyl phosphonium iodide (1.09g) and dispersant prepared as described in paragraph 1.3 above (136.41g) in high boiling aliphatic solvent b.p. 270-310°C (317.92 g) was heated with stirring. The temperature of the reaction
10 mixture was maintained at between 170-180°C for 2 hours. The mixture was allowed to cool to produce a dispersion having a 60% solids content of particle size 0.5µm, viscosity of 0.07Pas and epoxy equivalent weight of 6,200.

15 Example 2

2.1 Poly-2-Ethylhexyl Acrylate

A mixture of ethyl acetate (297.92 g),
2-ethylhexyl acrylate (198.60 g) and azodi-
isobutyronitrile (1.99 g) were mixed and heated to
20 reflux temperature. After 15 minutes at reflux temperature a further mixture of 2-ethylhexyl acrylate (496.52 g) and azodiisobutyronitrile (4.97 g) was added dropwise over 1.5 hours. Heating under reflux was continued for a further 1 hour and the product was
25 diluted with ethyl acetate to produce a solution of poly-2-ethylhexyl acrylate in ethyl acetate having a 65% solids content and viscosity of 0.9-1.1 Pas.

2.2 Poly-2-Ethylhexyl Acrylate: Methyl Methacrylate:
Acrylic Acid Dispersant

Charge 1

Poly-2-ethylhexyl acrylate		
5	(70% in ethyl acetate)	283.00g
	Ethyl acetate	85.08g
	Benzoyl peroxide	2.66g

Charge 2

Methyl methacrylate		
10	Acrylic acid	9.91g
	Benzoyl peroxide	7.96g

Charge 1 was made up and heated to reflux temperature for 0.5 hours. Charge 2 was then added at reflux temperature to charge 1 over 1.5 hours. The product so obtained was diluted first to 60% solids by addition of ethyl acetate (88.83 g) and then to 50% solids by addition of a further portion (132.00 g) of ethyl acetate. Heating at reflux temperature was continued and after a further 0.25 hours the solution was diluted to 45% solids by the addition of a further portion of ethyl acetate (88.65 g).

Heating at reflux temperature was continued and two portions of t-butyl per-2-ethylhexanoate (0.99 g) were added to the reaction mixture after 0.5 hourly intervals.

The reaction mixture was diluted with a further portion of ethyl acetate (110.81 g). Heating at reflux temperature was continued for 0.5 hours and a third portion of t-butyl per-2-ethylhexanoate (0.99 g) was added to the reaction mixture. The solvent was

then changed from ethyl acetate to a white spirit and ethyl acetate mixture by distilling off portions of ethyl acetate and replacing the volume distilled with an equal volume of white spirit.

- 5 The stabiliser so produced can be used in the method of Example 1.4 to prepare a dispersion of epoxy resin.

Example 3

3.1 Polybutadiene Methyl Methacrylate/Acrylic Acid

10 Dispersant

Charge 1

Toluene 593.08g

Polybutadiene (Lithene N4 5000) 199.47g

Charge 2

15 Methyl methacrylate 189.50g

Acrylic acid 9.97g

Benzoyl peroxide 5.32g

('Lithene' is a Trademark of Revertex)

- 20 Charge 2 was added over 1.5 hours to Charge 1 while Charge 1 was held at reflux temperature. Heating was continued for a further 1.5 hours and two portions (1.33g) of t-butyl peroxoate were added one each after two 0.5 hour intervals. The solution if allowed to cool produced a clear solution of resin
- 25 having a viscosity of 70 poise.

The solvent was then changed by portionwise distillation of toluene and addition of white spirit,

to give a solvent mixture having equal proportions of toluene and white spirit.

The stabiliser so produced can be used in the method of Example 1.4 to prepare a dispersion of epoxy resin.

Example 4

4.1 Polybutadiene Methyl Methacrylate/Methacrylic Acid Dispersant

Charge 1

10	Toluene	396.14
	Polybutadiene (Lithene N4 5000)	199.74
	White Spirit	197.74

Charge 2

	Methyl Methacrylate	187.74
15	Methacrylic acid	11.98
	Lucidol P 25 (Benzoyl peroxide containing 25% water)	5.33
20	Trigonox 21B 70 (tert butyl per - 2 - ethyl hexanoate)	1.33

Charge 2 was added over 1.5 hours to Charge 1 at 120 - 125°C, reflux temperature. After a further 0.5 hours the Trigonox was added, and heating was continued for a further hour. Solvent (99.1 parts)

was removed by distillation and replaced by an equal volume of white spirit.

The product was opalescent with a viscosity of 0.5 to 1.0 Pas and a measured solid content of 37%.

5 4.2 Epoxide Dispersion

Liquid Epoxy (GY 250 from Ciba Chemicals: 372.5 parts), diphenylol propane (DPP) (218.31 parts), triphenol ethyl phosphonium iodide (1.19 parts), dispersant from Example 4.1 (147.98 parts), and
10 Hydrosol PW2H (predominantly aliphatic solvent from Hydrocarbures St Denis France; 188.59 parts) were charged to a flask fitted with a separator and heated with stirring to 160°C. There was an initial exotherm to 180-190°C and the mixture was then maintained at
15 170-175°C. The mixture was maintained at 170-175°C and after 55 minutes further Hydrosol PW2H (71.43 parts) was added. The mixture was maintained at 170-175°C for 1 hour and then allowed to cool to room temperature. The cooled mixture was filtered through
20 a 50 micron nylon mesh. The epoxy equivalent weight was 6467 and the dispersion had a viscosity of 0.18 Pas seconds, and a solid content of 65%.

Examples 5 to 9

Dispersions were made by the method of Example 4.2
25 replacing the Hydrosol PW2H non-aqueous carrier with various other organic liquids. These liquids together with the characteristics of the dispersions obtained are shown in Table 1 below

('Hydrosol' solvents are available from Hydorcarbures
St Denis, France, 'Exxsol' 'Isopar' and 'Norpar'
solvents are available from Exxon Chemicals)

TABLE 1SOLVENT VARIANTS

5					DISPERSION		
	EX.	CARRIER	BP	TYPE	NON-	Pas	EEW
		LIQUID	°C		VOL.		
10	4.2	Hydrosol	270-	57% Alkanes			
		PW2H	310	40% Cyclo Alkane	65%	0.18	6467
				3% Aromatic			
15	5	Exxsol	240-	Dearomatised	65%	0.24	6334
		D 240-270	270				
20	6	Exxsol	280-	Dearomatised	65%	0.30	6738
		D 280-310	310				
25	7	Isopar M	205-	Isoparaffin	65%	0.11	6712
			255				
30	8	Isopar V	278-	Isoparaffin	65%	0.35	6915
			305				
	9	Norpar 15	252-	Linear paraffin	65%	0.115	6760
			277				

Examples 10 - 20

Dispersions were made according to the method of Example 4.2 but replacing the GY250 liquid epoxy with various other epoxy functional compounds, with the replacement of the DPP diol with several different diol compounds, and with slight variations in iodide catalyst, dispersant, and solvent weights. These are listed in Table 2 together with the properties of the resulting dispersions.

5 10 In Table 2:

ERL 4299 is a compound approximated by formula (5) of epoxy equivalent weight 202, available from Ciba Geigy Chemicals.

15 XPY 306 is a compound approximated by formula (11) in which D is methylene, of epoxy equivalent weight 156g from Ciba Geigy.

XPY 307 is an epoxy novolac resin of epoxy equivalent weight 178g from Ciba Geigy Chemicals.

20 EPN1139 is an epoxy novolac resin of epoxy equivalent weight 136g from Ciba Geigy Chemicals.

DEN 438 is an epoxy novolac resin of epoxy equivalent weight 155g from Dow Chemicals.

DER 330 is a compound approximated by formula (11) of epoxy equivalent weight 174g from Dow Chemicals.

25 DER 333 is an epoxide functional compound of approximate formula (11) of epoxy equivalent weight

185g available from Dow Chemicals, and which already contains a catalyst believed to be triphenyl ethyl phosphonium acetate.

- 5 Degussa Diepoxide 133 is a diepoxide compound of formula (8) from Degussa Chemicals of epoxy equivalent weight 133.

10 DPM is diphenylol methane, a diol of formula (1) in which D is methylene.

LMB 4337 is crude DPM from Ciba Geigy.

DPP is diphenylol propane, a diol of formula (1) in which D is a 2,2-propylene group.

TABLE 2

EX.	EPOXY (WT)	DIOL (WT)	CAT. WT	DISPERSANT WT TPEPI	SOLVT FW2H (WTS)	NVC VIS- CO	EEW
10	GY 250 (388,57g)	DPM (CIBA) 199.68g	1.17g	154,38g	184.78 +71.42	65% 0.24	6887
11	ERL 4299 (EEW 202) 390.58g	DPP 203.98g	1.11g	138.27g	194.42 +71.6	65% 0.152 Pas	4122
12	XPY 306 351,65g	DPP 235.10g	1.2g	159.41g	181.25 + 71.4g	65% 0.20 Pas	6041
13	XPY 307 372.5g	DPP 218,31g	1.19g	148g	188.59 + 71.4g	65% 0.24 Pas	4996
14	EPN 1139 372.5g	DPP 218.3g	1.19g	148g	188.59 + 71.4g	65% 0.192 Pas	4670
15	DEN 438 372.5g	DPP 218.3g	1.19g	148g	188.59 + 71.4g	65% 0.192 Pas	5316
16	DER 330 372.5g	DPP 218.3g	1.19g	148g	188.59 + 71.4g	65% 0.33 Pas	5020
17	DER 330 365,55g	DPP 225.26g	1.19g	148g	188.59 +71.4g	65% 0.25 Pas	7988
18	DER 333 372.5g	DPP 218.3g	1.19g	148g	188.59 +71.4g	65% 0.32 Pas	3772
19	Degussa Diepoxide 133 307.93g	DPP 249.85g	1.25g	169.36g	164.45 +107.16	62 % 0.23 Pas	2616
20	XPY 306 368.0	DPM (LMB 4337) 215.8	1.16g	166.80	176.79 +71.4g	65% 0.07 Pas	5565

Examples 21 to 31Dispersions with various ratios of epoxy compound to diol compound

5 Various epoxy dispersions were made by the process of Example 1.4 using the following ingredients:

GY250 Epoxy + Diphenylolpropane (DPP) diol	544.56 g
TPEPI Catalyst	1.09 g
PHSA dispersant from Example 1.3	136.41 g
Hydrosol PW2H Solvent	317.94 g

10 (GY250 is from Ciba Chemicals)
(TPEPI is triphenyl ethyl phosphonium iodide)

15 The total weight of epoxy and diol compound was kept constant while varying the ratio between the two. The ratios used and the properties of the dispersions obtained are given in Table 3 below:

Table 3Ratios of Epoxy to diol

5	<u>To give 544.56g</u>		<u>Theoretical</u>		<u>EEW</u>	<u>NVC</u>
	<u>EX.</u>	<u>WT GY250</u>	<u>WT DPP</u>	<u>EEW</u>	<u>Found</u>	<u>Visco</u>
						<u>Pas</u>
10	21	422.28	122.26	450	550	60%
						0.07
15	22	378.90	165.66	915	1182	60%
						0.072
20	23	355.58	188.98	2060	2663	60%
						0.072
25	24	349.71	194.85	3000	3660	"
	25	346.57	197.99	4000	4673	"
30	26	344.63	199.95	5000	5482	"
	27	343.35	201.23	6000	6194	"

Table 3 ContinuedRatios of Epoxy to Diol

5		<u>To give 544.56g</u>		Theoretical	EEW	NVC
	EX.	WT GY250	WT DPP	EEW	Found	Visco Pas
10	28	342.43	202.15	7000	6570	"
	29	340.79	203.79	10000	9578	"
15	30	338.87	205.71	20000	11570	"
	31	336.95	207.64	INFINITY	14941	"

Example 32 to 42Ratios of Epoxy Compound to Diol Compound32.1. to 42.1 Polybutadiene Dispersant

25 Methyl methacrylate (187.5 parts), methacrylic acid (11.97 parts) and Lucidol P25 (5.23 parts) were added to a mixture of Lithene N 4500 (199.47 parts) and toluene (11.17 parts) at reflux over 1.5 hours. The mixture was held at reflux for 0.5 hours and Trigonox 21B 70 (1.33 parts) was added. The mixture was heated

30

for 0.5 hours and more Trigonox 21B 70 (1.33 parts) was added. The mixture was held at reflux for a further 0.5 hours and about half the toluene was removed by distillation and replaced by white spirit.

- 5 The resulting product had a solid content of 40% and a viscosity of approximately 10 Pas.

32 to 42 Epoxy Dispersions

Epoxy dispersions were made using the method of 4.2 and the following ingredients:

10	GY250 epoxy + diphenylol propane	590.91
	TPEPI Catalyst	1.19
	Polybutadiene dispersant	
	from Example 32.1 to 42.1	147.98
	Hydrosol PW2H solvent	188.59
15		+ 71.43

The total weight of epoxy compound and diol compound was kept constant and the ratio between the two was varied the various weights of these together with properties of the dispersions obtained are shown in

20 Table 4.

Table 4Ratios of Epoxy to Diol

5	EX.	<u>To give 590.81</u>		Theoretical	EEW	NVC
		WT GY250	WT DPP	EEW	Found	Visco
						Pas
10	32	411.08	179.73	915	1145	65%
						0.224
						Pas
15	33	385.78	205.03	2060	2643	65%
						0.223
						Pas
20	34	379.42	211.39	3000	4173	65%
						0.223
						Pas
25	35	376.00	214.81	4000	5065	65%
						0.253
						Pas
30	36	373.90	216.91	5000	5917	65%
						0.235
						Pas

Table 4 ContinuedRatios of Epoxy to Diol

	EX.	<u>To give 590.81</u>		Theoretical	EEW	NVC
		WT GY250	WT DPP	EEW	Found	Visco
						Pas
5	37	372.50	218.31	6000	6630	65%
						0.186
10						Pas
	38	371.50	219.31	7000	7184	65%
						0.258
15						Pas
	39	370.76	220.05	8000	8014	65%
						0.230
20						Pas
	40	369.71	221.10	10000	7953	65%
						0.224
25						Pas
	41	367.62	223.9	20000	9986	65%
						0.186
30						Pas
	42	365.56	225.25	INFINITY	11348	65%
						0.152
35						Pas

Example 43Dispersions Using an Acid Free Dispersant43.1 The Dispersant

5 Methylmethacrylate (177.47 parts) and Lucidol P25
(4.73 parts) were added to a mixture of Lithene N4
5000 (221.54 parts) and toluene (593.85 parts) at
reflux temperature over 1.5 hours. The mixture was
held at reflux temperature for a further 30 minutes
and Trigonox 21B70 (1.18 parts) was added. The
10 mixture was held at reflux ratio 0.5 hours and more
Trigonox 21B70 (1.18 parts) was added. The mixture
was held at reflux temperature for a further 0.5 hours
and half of the toluene was then removed by
distillation and replaced by white spirit (296 parts).
15 The resulting dispersant was jelly like and had a
solid content of 37%.

43.2 Epoxy Dispersion

GY250 liquid epoxy (372.5 parts), DPP diol
(218.30 parts), triphenyl ethyl phosphonium iodide
20 catalyst (1.19 parts), dispersant from example 43.1
(147.99 parts) and Hydrosol PW2H solvent (188.59
parts) were heated to 160°C with stirring. The
temperature rose by exotherm to 175 - 185°C, and the
time at which it reached 170°C was taken as time 0.
25 55 minutes after this time Hydrosol PW2H (71.43 parts)
was added. The mixture was held at 170°C for a
further 1 hour and 5 minutes and allowed to cool. The

product was a milky dispersion with a solids content of 65%, a viscosity of 0.25 Pas, and an epoxy equivalent weight of 5900.

Example 44

5 Dispersions of Non-epoxy Functional Polymer

GY 250 liquid epoxy (343.26 parts), DPP diol (307.50 parts), TPEPI Catalyst (1.31 parts), the dispersant from example 4.1 (122.3 parts) and Hydrosol PW 2H solvent (225.63 parts) were heated to 160°C with stirring. The heat was removed and the temperature of the mixture continue to rise to 170°C, and the time at which it reached 170°C was taken as time zero. The temperature of the mixture continued to rise to 180-190°C and when the temperature had ceased to rise the mixture was maintained at 170-175°C. After one hour the epoxy equivalent in weight of the mixture was 100.000, and after two hours the epoxy equivalent weight was 211.000. After two hours the mixture was cooled and filtered through a 50 microns Nylon mesh. The cooled mixture had a 70% solid content and a viscosity of 0.6 Pas.

Example 45

GY 250 liquid epoxy (379.32 parts), diphenylol propane (270.53 parts), triphenyl ethyl phosphonium iodide catalyst (1.31 parts), the dispersant from example 4.1 (122.11 parts) and Hydrosol PW 2H solvent (226.73 parts) were heated to 160°C with stirring. The heat was removed and the temperature of the mixture continue to rise to 170°C, and the time at

which it reached 170°C was taken as time zero. The temperature of the mixture continued to rise to 180-190°C and when the temperature had ceased to rise the mixture was maintained at 170-175°C. After one
5 hour the epoxy equivalent in weight of the mixture was 34.890, and after two hours the epoxy equivalent weight was 76.423. After two hours the mixture was cooled and filtered through a 50 microns Nylon mesh. The cooled mixture had a 70% solid content and a
10 viscosity of 0.6 Pas.

Example 46

GY 250 liquid epoxy (260.62 parts), diphenylol propane (330.16 parts), triphenyl ethyl phosphonium iodide catalyst (1.30 parts), the dispersant from example 4.1
15 (147.75 parts) and Hydrosol PW 2H solvent (188.69 parts) were heated to 160°C with stirring. The heat was removed and the temperature of the mixture continue to rise to 170°C, and the time at which it reached 170°C was taken as time zero. The temperature
20 of the mixture continued to rise to 180-190°C and when the temperature had ceased to rise the mixture was maintained at 170-175°C. After one hour the epoxy equivalent in weight of the mixture was 141,000, and after two hours the epoxy equivalent weight was
25 197.925. After two hours the mixture was cooled and filtered through a 50 microns Nylon mesh. The cooled mixture was very thick at 70% thus a part was diluted to 65% solids giving 0.29 Pas.

Example 4;Epoxide Dispersion

Liquid Epoxy (GY 250 from Ciba Chemicals: 374.65 parts), diphenylol propane (141.78 parts), adipic acid (49.03 parts) triphenyl ethyl phosphonium iodide (1.19 parts), dispersant from Example 4.1 (148.84 parts), and Hydrosol PW2H (predominantly aliphatic solvent from Hydrocarbures St Denis France: 177.36 parts) were charged to a flask fitted with a separator and heated with stirring to 160°C. There was an initial exotherm to 180-190°C and the mixture was then maintained at 170-175°C. The mixture was maintained at 170-175°C and after 55 minutes further Hydrosol PW2H (107.15 parts) was added. The mixture was maintained at 170-175°C for 1 hour and then allowed to cool to room temperature. The cooled mixture was filtered through a 50 micron nylon mesh. The epoxy equivalent weight was 8517 and the dispersion had a viscosity of 0.3 Pas and a solid content of 62.59%.

20 Example 48Epoxide Dispersion

Liquid Epoxy (GY 250 from Ciba Chemicals: 316.81 parts), diphenylol propane (168.46 parts), dimerised fatty acid (Pripol 1013 from Unichem), (39.77 parts) triphenyl ethyl phosphonium iodide (1.01 parts), dispersant from Example 4.1 (125.92 parts), and Hydrosol PW2H (predominantly aliphatic solvent from Hydrocarbures St Denis France: 169.20 parts) were charged to a flask fitted with a separator and heated with stirring to 160°C. There was an initial exotherm to 180-190°C and the mixture was then maintained at

170-175°C. The mixture was maintained at 170-175°C and after 55 minutes Hydrosol PW2H (63.41 parts) was added. The mixture was maintained at 170-175°C for 35 minutes Hydrosol PW2H (73.76 parts) was added and the
 5 mixture was held at 170° to 175°C for 30 minutes. Hydrosol PW2H (41.66 parts) was added and the mixture was allowed to cool to room temperature. The cooled mixture was filtered through a 50 micron nylon mesh. The epoxy equivalent weight was 6170 and the
 10 dispersion had a viscosity of 0.17 Pas and a solid content of 57½%.

Application of the Dispersions to Metal Substrates

Each of the dispersions from examples 1 to 48 was applied to a steel substrate. The application was
 15 carried out using a spinning panel in the following general method. A 15cm x 15cm panel was spun at 2950 rpm and 5 to 6g of the dispersion was placed on its surface at its centre. Spinning was continued for 10 seconds.

20 Each of the coated panels was heated to 200°C for 10 minutes in a box oven to remove the continuous phase. The dry films were all of 8g/m² film weight (approximately 6μ thickness).

Film Properties

25 All of the dispersions formed good coherent films.

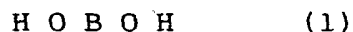
It was found that the dispersion from example 1 and 21 to 31 produced a film which had poor adhesion to the metal substrate.

It was found that the dispersion from example 2 produced a film which was rather soft and which had somewhat poor adhesion to the substrate.

It was found that the dispersions from examples 3 to 20 and 32 to 48 all produced films which had excellent adhesion to the metal substrate.

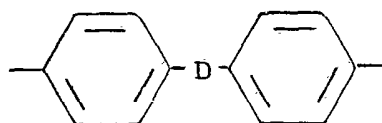
The claims defining the invention are as follows:

1. A process for preparing a sterically stabilised non aqueous dispersion of a polyepoxide of epoxy equivalent weight in the range 350 to infinity, which
 5 comprises reacting a sterically stabilised non-aqueous dispersion of a compound with at least two epoxy groups with a diol of formula (1)



in which B is a group of formula (2)

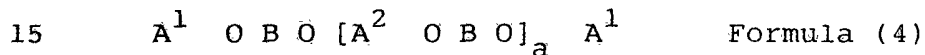
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(2)

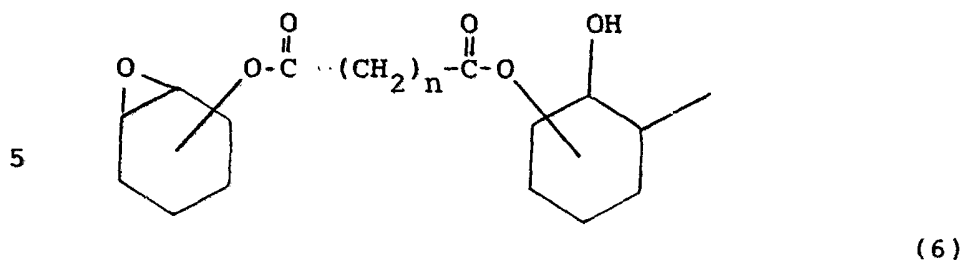
where D is a methylene group or propane -2, 2-diyl.

2. A process as claimed in Claim 1 in which the polyepoxide is of formula (4)

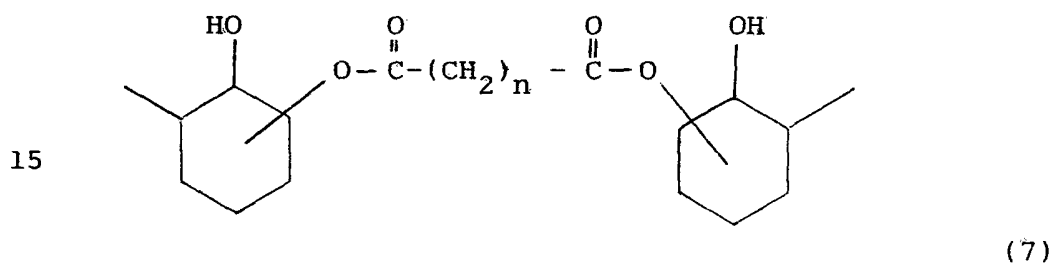


in which a is a number such that the epoxy equivalent weight is in the range 350 to infinity, B is a group of formula (2) and,

A^1 is hydrogen or a group of formula (6)

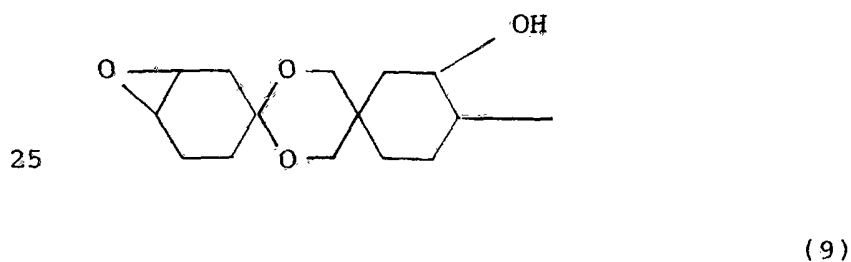


10 in which n is from 1 to 4, and A^2 is a group of formula (7)

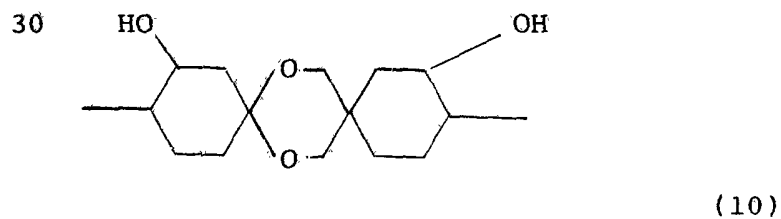


in which n is as in formula (6) or;

20 A^1 is hydrogen or a group of formula (9)

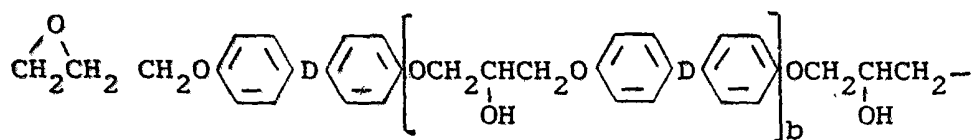


and A^2 is a group of formula (10)



35

or; A^1 is hydrogen or a group of formula (12).

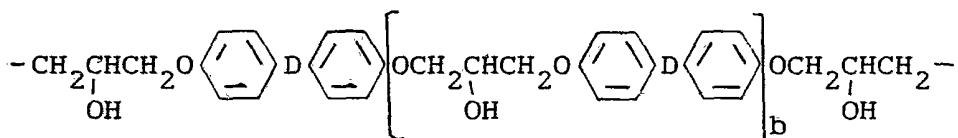


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(12)

D is a methylene group or propane -2, 2-diyl and $\underline{b}$ is from 0 to 2, and A^2 is a group of formula (13)

10



(13)

15

in which D and $\underline{b}$ are as in formula (12).

3. A process as claimed in Claim 1 in which the compound with at least two epoxy groups is an epoxy novolac compound.

4. A process as claimed in Claim 2 in which A^1 is hydrogen or a group of formula (12), A^2 is a group of formula (13) and D is propane -2, 2-diyl.

5. A process as claimed in Claim 4 in which $\underline{b}$ is 0.1 to 1.

6. A process as claimed in Claim 2 in which A^1 is hydrogen or a group of formula (6), A^2 is a group of formula (7) and $\underline{n}$ is 4.

7. A process as claimed in Claim 1, in which D is propane -2, 2 -diyl.

8. A process as claimed in any one of Claims 1 to 7
5 in which the epoxy equivalent weight is in the range 350 to 500,000.

9. A process as claimed in Claim 8 in which the epoxy equivalent weight is in the range 350 to 250,000.

10. A process as claimed in Claim 9 in which the
10 epoxy equivalent weight is in the range 350 to 25,000.

11. A process as claimed in any one of Claims 1 to 10
15 in which the steric stabiliser for the epoxy resin comprises an anchor component associated with the epoxy resin which is a homopolymer of methyl methacrylate or a copolymer of methyl methacrylate and acrylic or methacrylic acid, and a solvated component derived from polybutadiene.

12. A process as claimed in any one of Claims 1 to 11
20 in which the non-aqueous continuous phase is an aliphatic hydrocarbon with a boiling point in the range 130-350°C.

13. A sterically stabilised non-aqueous dispersion of a polyepoxide produced according to the process as claimed in any one of Claims 1 to 12 which is
25 maintained in a stable state of dispersion by a steric stabiliser which comprises an anchor component associated with the epoxy resin which is a homopolymer

of methylmethacrylate or a copolymer of methylmethacrylate and acrylic or methacrylic acid and a solvated component derived from polybutadiene.

5 14. A sterically stabilised non-aqueous dispersion as claimed in Claim 13 which has a solids content of at least 60%.

10 15. A coating process which comprises the steps applying a film of the dispersion as claimed in Claim 13 to a suitable substrate and removing the continuous phase by evaporation.

16. A coated article which has been coated according to a process as claimed in Claim 15.

~~DATED: 14 November 1988~~

PHILLIPS ORMONDE & FITZPATRICK

Attorneys For:

IMPERIAL CHEMICAL INDUSTRIES PLC and
HOLDEN EUROPE SA

David B. Fitzpatrick



17. A process according to claim 1, substantially as hereinbefore described with reference to any one of the examples.

DATED: 24 January 1991

PHILLIPS ORMONDE & FITZPATRICK

Attorneys For:

IMPERIAL CHEMICAL INDUSTRIES PLC and

HOLDEN EUROPE SA

David B Fitzpatrick



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